

Description

The AH284 is a single-chip solution for driving two-coil brushless direct current (BLDC) fans and motors. The device includes a Hall-effect sensor, dynamic offset correction and two complementary open-drain output drivers with internal Zener diode protection.

To help protect the motor coils, the AH284 provides Rotor Lock Protection which shuts down output drives if rotor lock is detected. The device automatically re-starts when the rotor lock is removed.

The AH284 is available in SIP-4 and SOT89-5 packages.

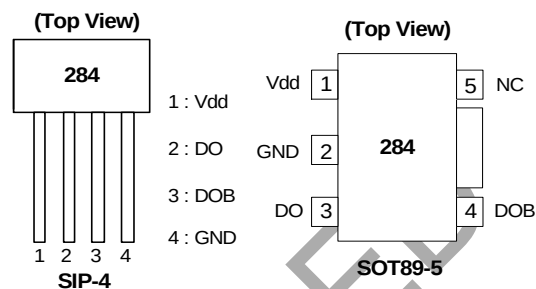
Features

- Single-chip Solution
- Operating Voltage: 3.8V to 20V
- Built-in Hall Sensor and Input Amplifier
- Rotor Lock Protection (Lock detection, output shutdown and automatic re-start)
- Built-in Zener Protection for Output Driver
- Average Output Current up to 500mA
- Packages: SIP-4 and SOT89-5
- Green Molding Compound
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

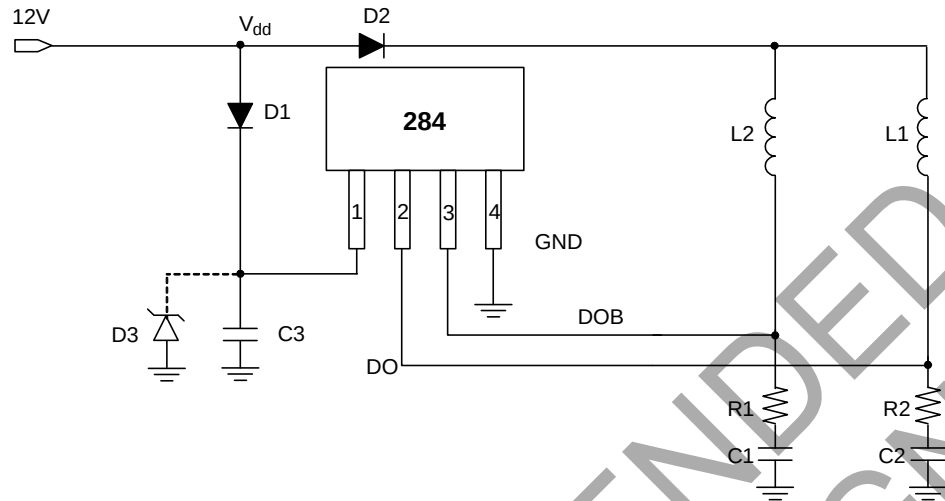
Pin Assignments



Applications

- Two-coil BLDC Cooling Fans
- Low to Medium Voltage, Low Power BLDC Motors

Typical Application Circuit (Note 4)

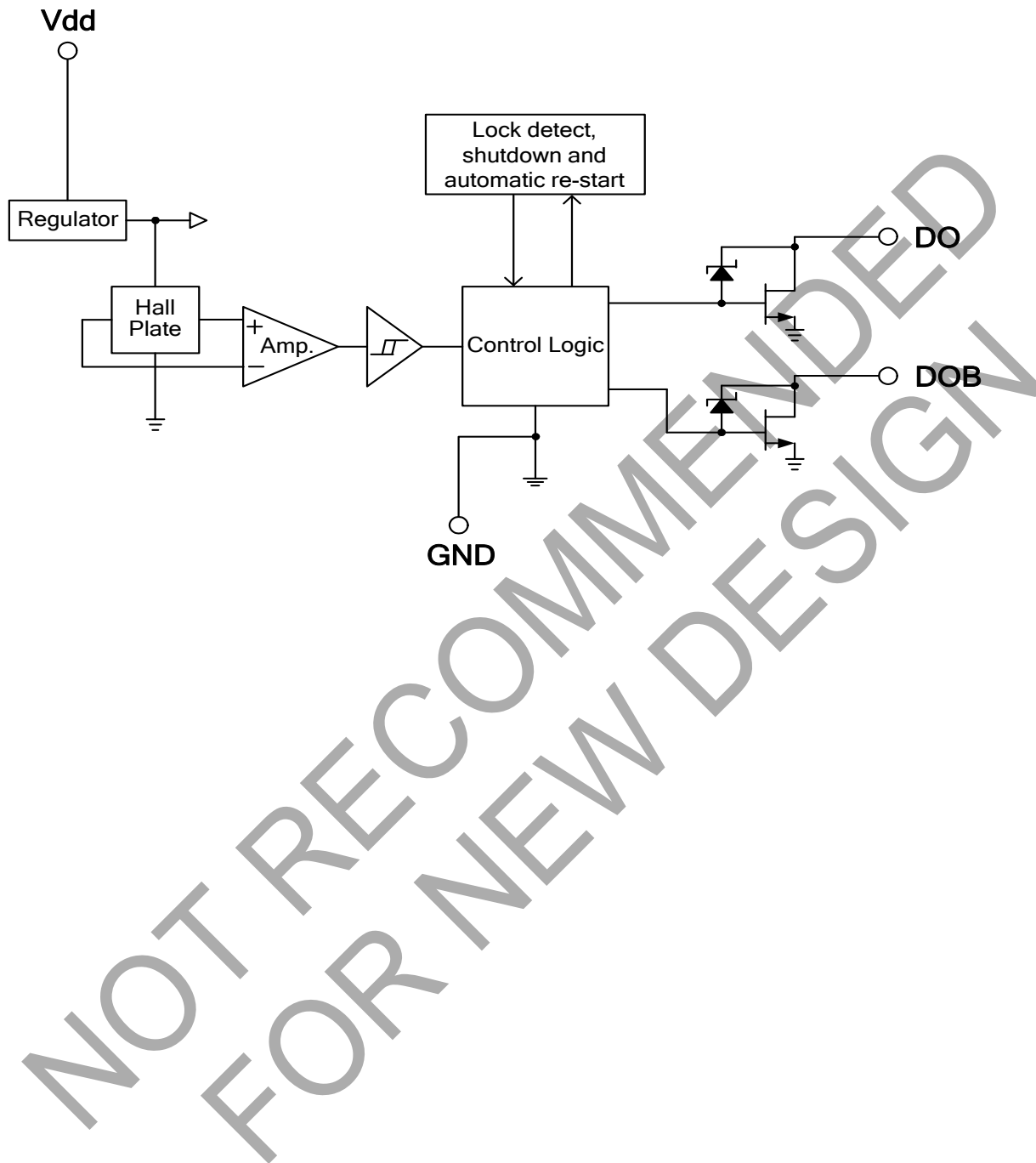


Note: 4. Typically it is recommended to use a 56Ω resistor for R1 and R2 and a 2.2μF E-Cap capacitor for C1, C2 and C3. These values may need to be optimized depending on the coils used.
To help with IC protection it's advised to add a Zener diode between Vdd and ground. The Zener diode should be chosen to help prevent the supply voltage exceeding the maximum rating of the device.

Pin Descriptions

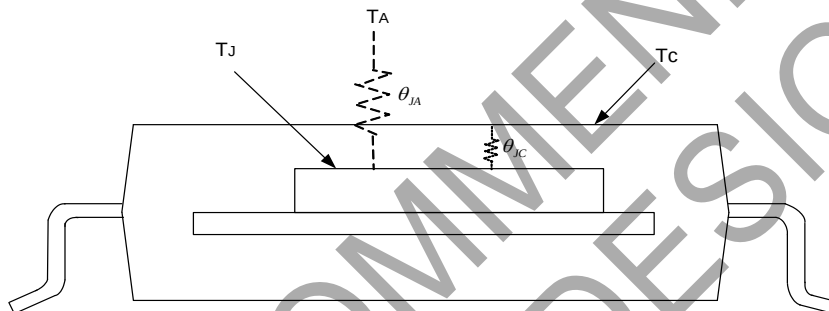
Pin Name (SOT89-5)	Description
Vdd	Input Power
DO	Output Pin
DOB	Output Pin
GND	Ground
NC	Not Connected

Functional Block Diagram



Absolute Maximum Ratings ($T_A = +25^\circ\text{C}$)

Symbol	Characteristics			Rating	Unit
V_{DD}	Supply Voltage			24	V
I_O	Output Current	$I_{O(AVE)}$	SIP-4	500	mA
			SOT89-5	500	mA
		$I_{O(PEAK)}$		700	mA
P_D	Power Dissipation	SIP-4		550	mW
		SOT89-5		800	mW
T_{ST}	Storage Temperature			-55 to +150	$^\circ\text{C}$
T_J	Maximum Junction Temperature			+150	$^\circ\text{C}$
θ_{JA}	Thermal Resistance Junction to Case (Note 5)	SIP-4		227	$^\circ\text{C/W}$
		SOT89-5		156	$^\circ\text{C/W}$



Note: 5. θ_{JA} should be confirmed with heat sink thermal resistance. If there is no heat sink contact, θ_{JA} will almost be the same as θ_{JC} .

Recommended Operating Conditions

Symbol	Characteristic	Conditions	Min	Max	Unit
V_{DD}	Supply Voltage	Operating	3.8	20	V
T_A	Operating Ambient Temperature	Operating	-40	+100	$^\circ\text{C}$

Electrical Characteristics (T_A = +25°C, V_{DD} = 12V, unless otherwise specified.)

Symbol	Characteristics	Conditions	Min	Typ.	Max	Unit
I _{DD}	Supply Current	Operating	-	2.0	4.0	mA
I _{OFF}	Output Leakage Current	V _{OUT} = 24V	-	< 0.1	10	μA
t _{RLP-ON}	Rotor Lock Protection On Time	-	0.4	0.5	0.6	Sec
t _{RLP-OFF}	Rotor Lock Protection Off Time	-	2.4	3	3.6	Sec
V _{OUT(SAT)}	Output Saturation Voltage	I _O = 300mA	-	375	500	mV
		I _O = 500mA	-	625	900	
R _{DS(ON)}	Output On Resistance	I _O = 300mA	-	1.25	1.67	Ω
V _Z	Output Zener-Breakdown Voltage	-	35	42	60	V

Truth Table

IN-	IN+	CT	OUT1	OUT2	Mode
H	L	L	H	L	Rotating
L	H	L	L	H	Rotating
-	-	H	Off	Off	Lockup protection activated

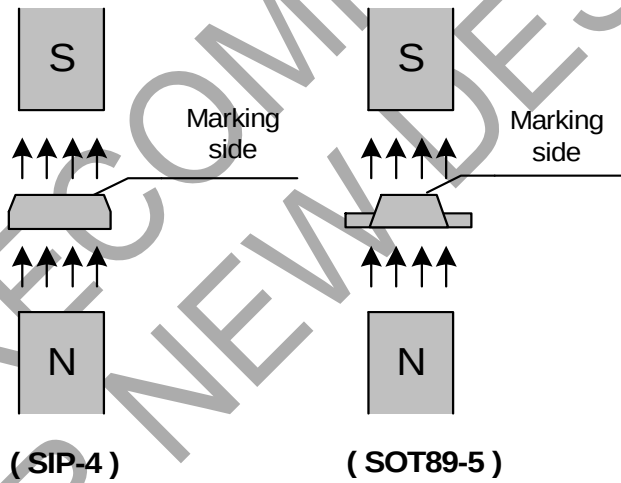
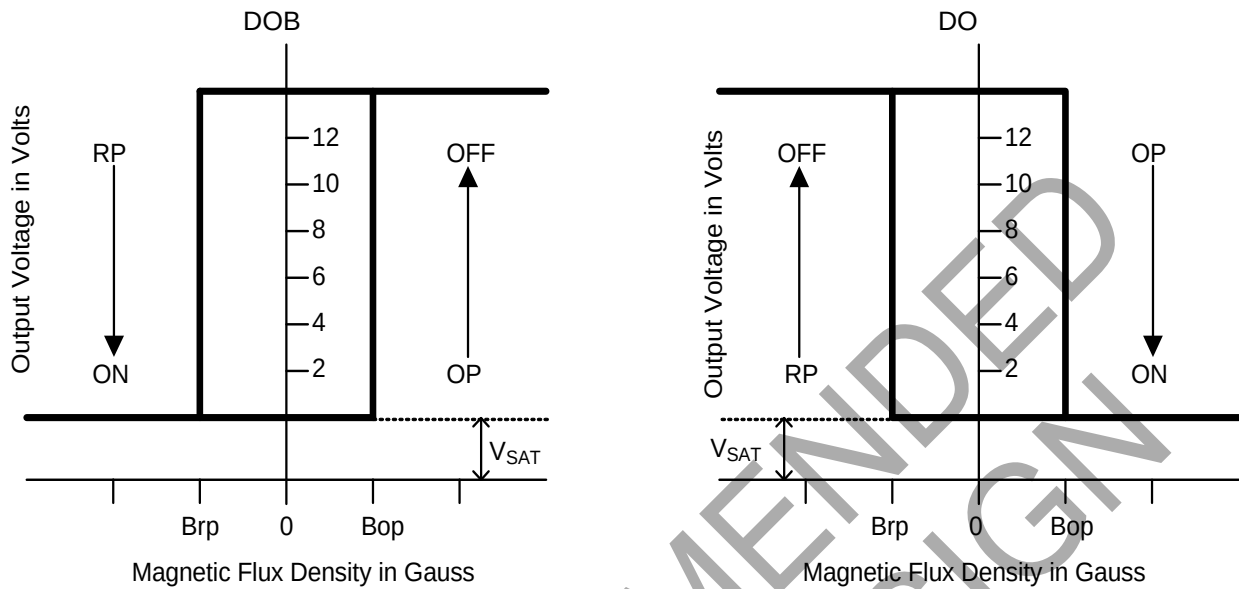
Magnetic Characteristics (T_A = +25°C, V_{DD} = 12V, unless otherwise specified, Note 6)

(1mT = 10 Gauss)

Symbol	Characteristics	Min	Typ.	Max	Unit
Bop	Operation Point	10	30	60	Gauss
Brp	Release Point	-60	-30	-10	Gauss
Bhy	Hysteresis	-	60	-	Gauss

Note: 6. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

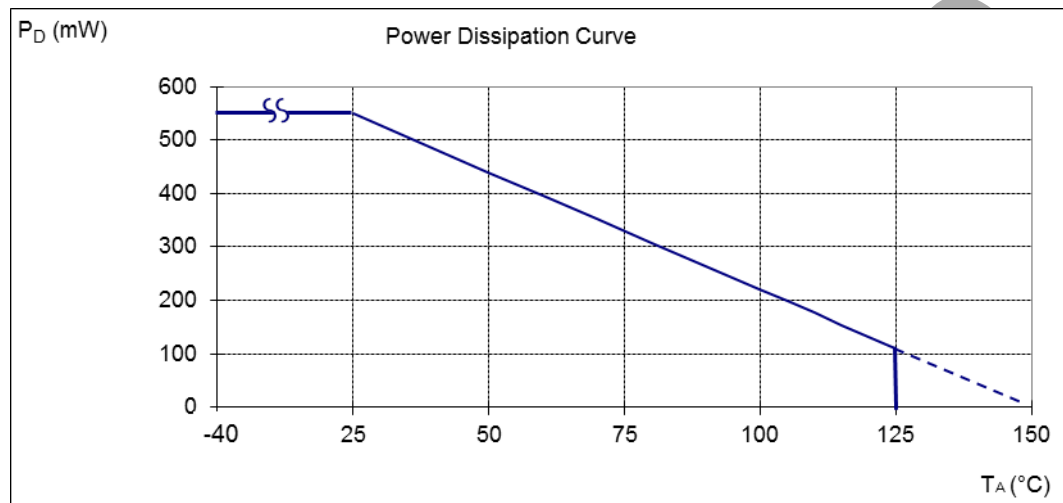
Operating Characteristics



Performance Characteristics

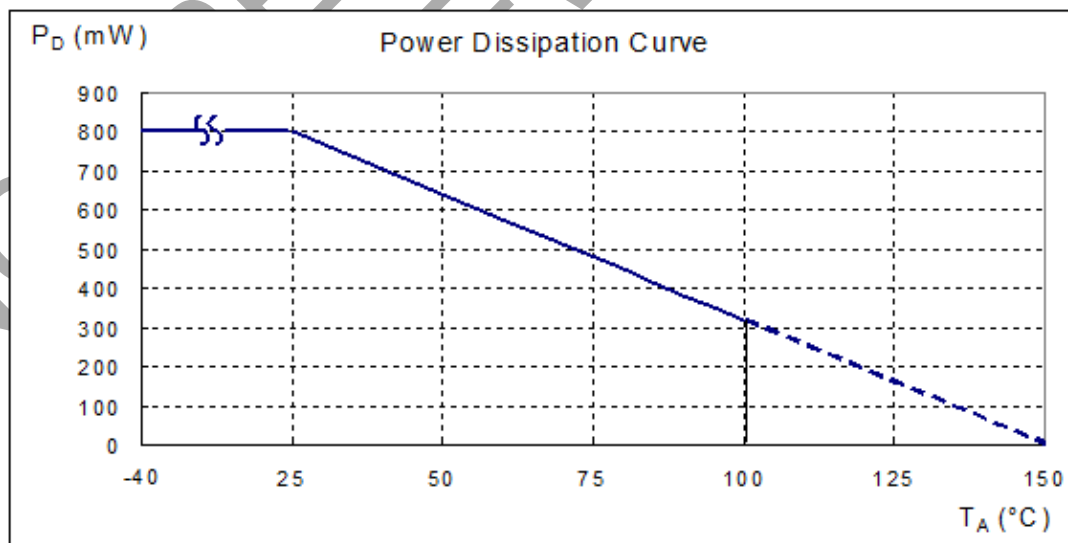
(1) SIP-4

T_A (°C)	25	50	60	70	80	85	90	95	100
P_D (mW)	550	440	396	352	308	286	264	242	220
T_A (°C)	105	110	115	120	125	130	135	140	150
P_D (mW)	198	176	154	132	110	88	66	44	0

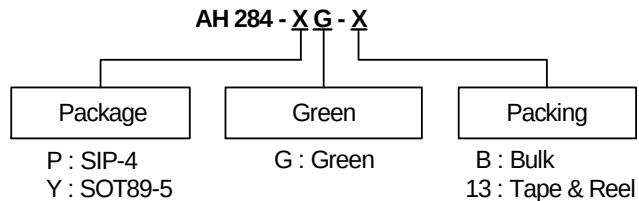


(2) SOT89-5

T_A (°C)	25	50	60	70	75	80	85	90	95	100
P_D (mW)	800	640	576	512	480	448	416	384	352	320
T_A (°C)	105	110	115	120	125	130	135	140	145	150
P_D (mW)	288	256	224	192	160	128	96	64	32	0



Ordering Information

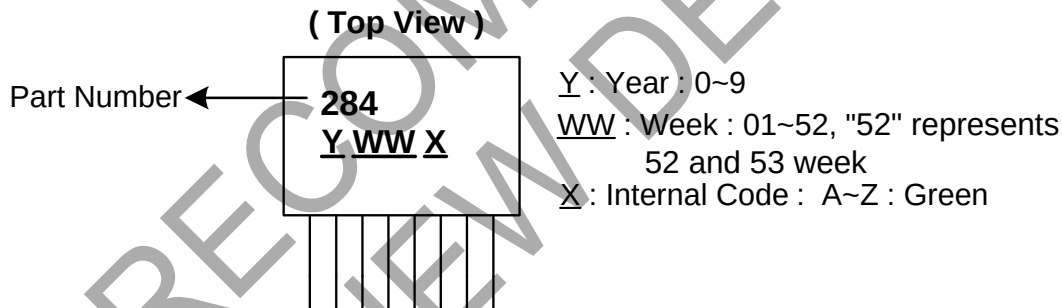


Device	Status (Note 9)	Package Code	Packaging (Note 7, 8)	Bulk		13" Tape and Reel	
				Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH284-PG-B	NRND	P	SIP-4	1000	-B	NA	NA
AH284-YG-13	NRND	Y	SOT89-5	NA	NA	2500/Tape & Reel	-13

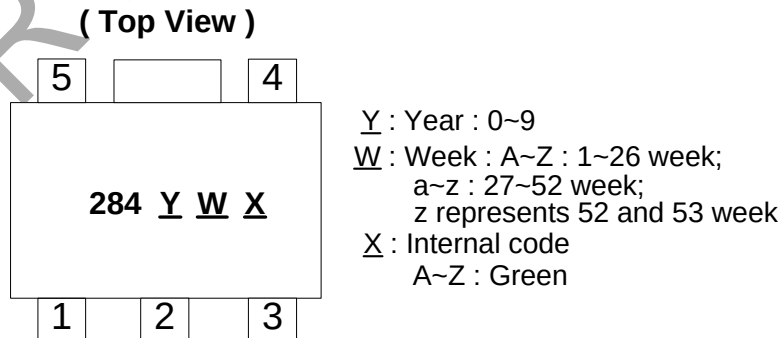
Notes: 7. Pad layout as shown on Diodes Incorporated's suggested pad layout document, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
8. Reverse taping as shown on Diodes Incorporated's Surface Mount (SMD) Packaging document AP02007, which can be found on our website <http://www.diodes.com/datasheets/ap02007.pdf>.
9. NRND = Not Recommended for New Design.

Marking Information

(1) SIP-4



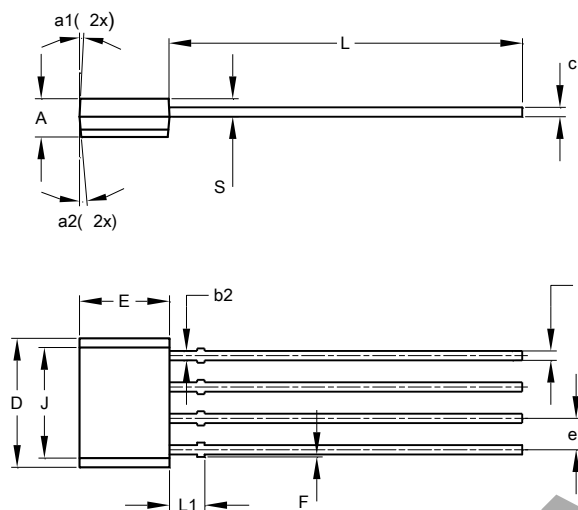
(2) SOT89-5



Package Outline Dimensions (All Dimensions in mm)

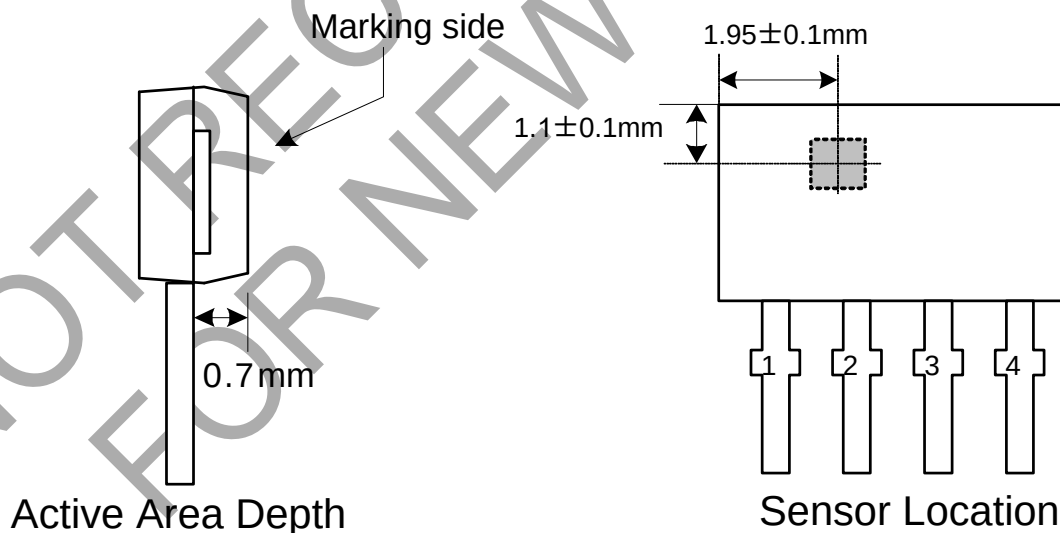
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SIP-4



SIP-4			
Dim	Min	Max	Typ
A	1.45	1.65	1.55
b1	0.38	0.44	0.40
b2	-	-	0.48
c	0.35	0.45	0.40
D	5.12	5.32	5.22
e1	1.24	1.30	1.27
E	3.55	3.75	3.65
F	0.00	0.20	-
J	4.10	4.30	4.20
L	14.00	14.60	14.30
L1	1.32	1.52	1.42
S	0.63	0.83	0.73
a1	-	5°	3°
a2	4°	7°	5°
a3	4°	7°	5°
a4	-	5°	3°

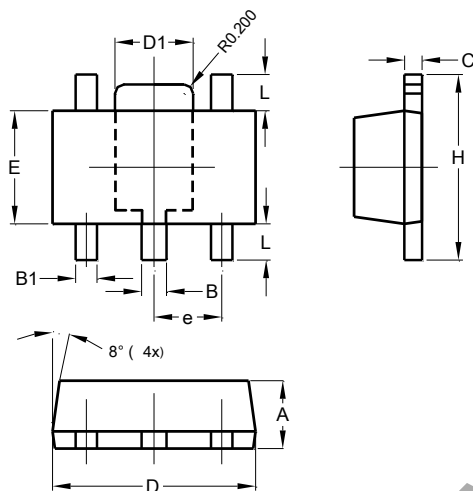
All Dimensions in mm



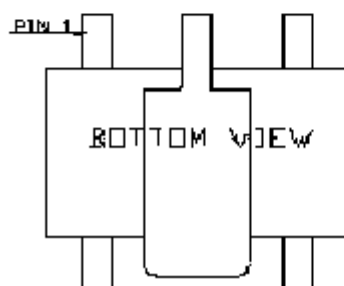
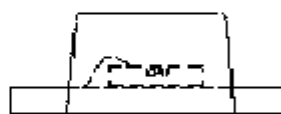
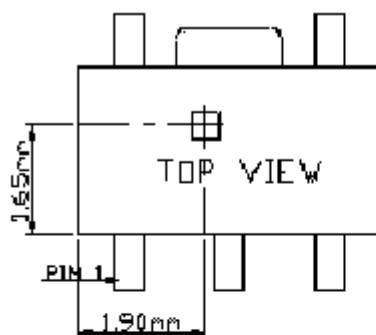
Package Outline Dimensions (Cont.)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(2) Package Type: SOT89-5



SOT89-5			
Dim	Min	Max	Typ
A	1.40	1.60	1.50
B	0.50	0.62	0.56
B1	0.44	0.54	0.48
C	0.35	0.43	0.38
D	4.40	4.60	4.50
D1	1.62	1.83	1.733
E	2.40	2.60	2.50
e	-	-	1.50
H	3.95	4.25	4.10
L	0.65	0.95	0.80
All Dimensions in mm			

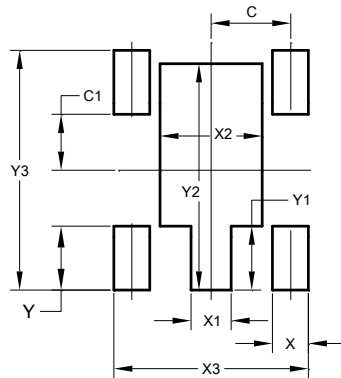


Sensor Location

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT89-5



Dimensions	Value (in mm)
C	1.500
C1	1.050
X	0.680
X1	0.760
X2	1.930
X3	3.680
Y	1.200
Y1	1.200
Y2	4.250
Y3	4.500

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